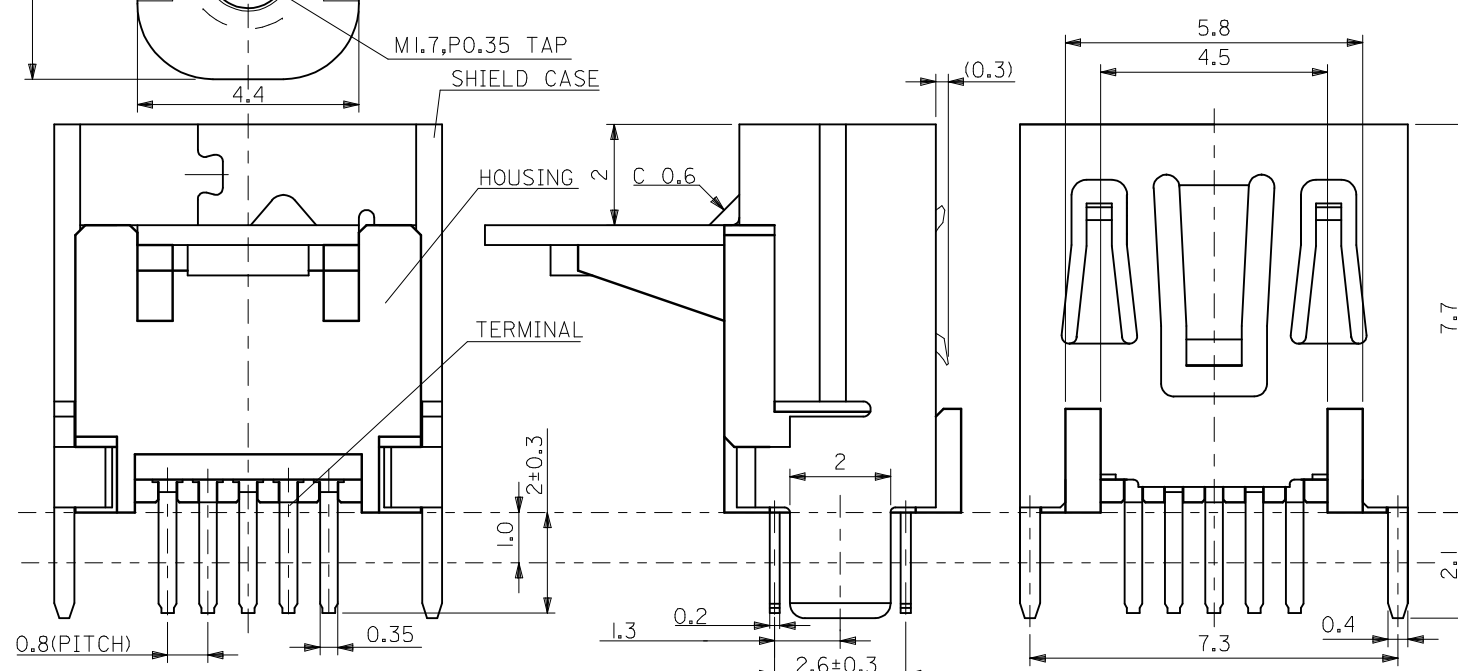


推奨基板寸法
RECOMMENDED P.C.B. PATTERN LAYOUT

注記
NOTES

- 材質
MATERIAL
ハウジング: ポリアミド, 黒色, UL 94V-0
HOUSING: POLYAMIDE, BLACK, UL94V-0
ターミナル: 銅合金 (t=0.2)
TERMINAL: COPPER ALLOY (t=0.2)
シールド ケース: 銅合金 (t=0.4)
SHIELD CASE: COPPER ALLOY (t=0.4)
- メッキ仕様
PLATING
ターミナル: 接点部: 金メッキ
TERMINAL: CONTACT AREA: GOLD PLATING
半田付け部: 錫メッキ
SOLDER TAIL AREA: TIN PLATING
下地部: ニッケルメッキ
UNDER PLATING: NICKEL
シールド ケース: 錫メッキ
SHIELD CASE: TIN PLATING
下地部: ニッケルメッキ
UNDER PLATING: NICKEL
- 本製品は 500075-1509 の鉛フリー品である。
THIS PRODUCT IS LEAD FREE OF 500075-1509



500075-1507
TRAY PACKAGE
ORDER No.

REVISED EC NO: J2009-1533 DRW: NESATO 2009/06/25 CHKD: MATSUMOTO 2009/06/25 APPR: NUKITA 2009/06/25 REV A	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE ---	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION
	10 UNDER	±0.2	DRAWN BY M. NABE I	DATE 2004/03/16	TITLE USB MINI-B STRAIGHT TYPE REC. ASS'Y -LEAD FREE-		
	10 OVER 30 UNDER	±0.25	CHECKED BY K. TOJO	DATE 2004/03/16	MOLEX INCORPORATED		
	30 OVER	±0.3	APPROVED BY M. SASAO	DATE 2004/03/16	DOCUMENT NO. SD-500075-006		
ANGULAR ±3 °		MATERIAL NO. SEE TABLE		SHEET NO. 1 OF 1			
DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION					